



General Features

- N-Channel

$V_{DS} = 40V, I_D = 8A$

$R_{DS(ON)} < 19m\Omega @ V_{GS}=10V$

$R_{DS(ON)} < 29m\Omega @ V_{GS}=4.5V$

- P-Channel

$V_{DS} = -40V, I_D = -7A$

$R_{DS(ON)} < 35m\Omega @ V_{GS}=-10V$

$R_{DS(ON)} < 45m\Omega @ V_{GS}=-4.5V$

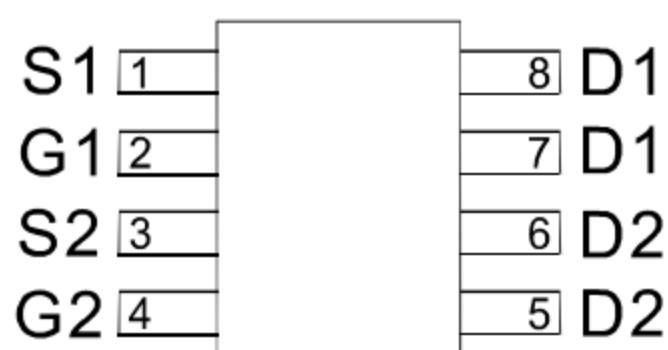
Application

- High power and current handing capability
- Lead free product is acquired
- Surface mount package

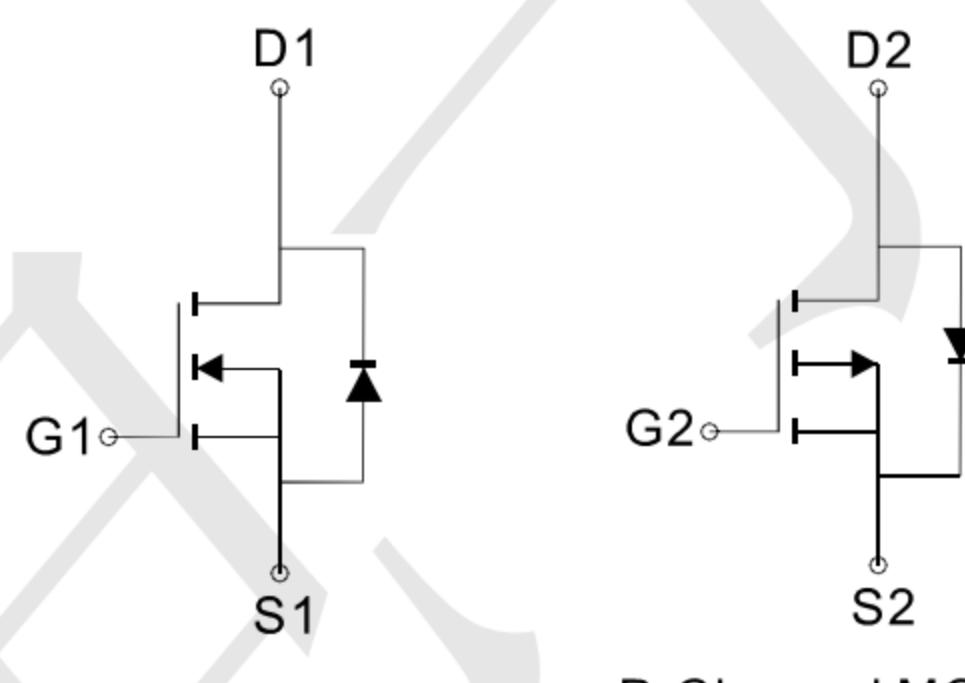
Package and Pin Configuration

(SOP-8)

Top View

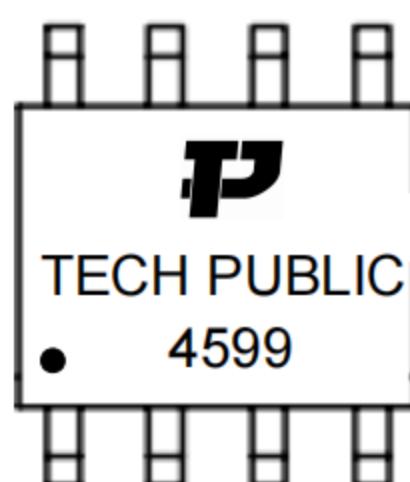


Circuit diagram



P-Channel MOSFET

Marking



Absolute Maximum Ratings ($T_A=25^\circ C$ unless otherwise noted)

| Parameter | Symbol | N-Channel | P-Channel | Unit |
|--|----------------|------------|------------|------|
| Drain-Source Voltage | V_{DS} | 40 | -40 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | ± 20 | V |
| Continuous Drain Current $T_A=25^\circ C$ | I_D | 8 | -7 | A |
| | | 6 | -5.5 | |
| Pulsed Drain Current ^(Note 1) | I_{DM} | 40 | -30 | A |
| Maximum Power Dissipation | P_D | 2.0 | 2.0 | W |
| Operating Junction and Storage Temperature Range | T_J, T_{STG} | -55 To 150 | -55 To 150 | °C |

Thermal Characteristic

| | | | | |
|---|-----------------|------|------|------|
| Thermal Resistance, Junction-to-Ambient ^(Note 2) | $R_{\theta JA}$ | N-Ch | 62.5 | °C/W |
| Thermal Resistance, Junction-to-Ambient ^(Note 2) | $R_{\theta JA}$ | P-Ch | 62.5 | °C/W |



N-CH Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|--|--------------------------|--|-----|-----|-----------|------------------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$ | 40 | - | - | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{\text{DS}}=40\text{V}, V_{\text{GS}}=0\text{V}$ | - | - | 1 | μA |
| Gate-Body Leakage Current | I_{GSS} | $V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$ | - | - | ± 100 | nA |
| On Characteristics ^(Note 3) | | | | | | |
| Gate Threshold Voltage | $V_{\text{GS(th)}}$ | $V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$ | 1 | 1.5 | 2.0 | V |
| Drain-Source On-State Resistance | $R_{\text{DS(ON)}}$ | $V_{\text{GS}}=10\text{V}, I_{\text{D}}=8\text{A}$ | - | 14 | 19 | $\text{m}\Omega$ |
| | | $V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=4\text{A}$ | - | 19 | 29 | $\text{m}\Omega$ |
| Forward Transconductance | g_{FS} | $V_{\text{DS}}=5\text{V}, I_{\text{D}}=8\text{A}$ | 33 | - | - | S |
| Dynamic Characteristics ^(Note 4) | | | | | | |
| Input Capacitance | C_{iss} | $V_{\text{DS}}=20\text{V}, V_{\text{GS}}=0\text{V}, F=1.0\text{MHz}$ | - | 415 | - | PF |
| Output Capacitance | C_{oss} | | - | 112 | - | PF |
| Reverse Transfer Capacitance | C_{rss} | | - | 11 | - | PF |
| Switching Characteristics ^(Note 4) | | | | | | |
| Turn-on Delay Time | $t_{\text{d(on)}}$ | $V_{\text{DD}}=20\text{V}, R_{\text{L}}=2.5\Omega, V_{\text{GS}}=10\text{V}, R_{\text{GEN}}=3\Omega$ | - | 4 | - | nS |
| Turn-on Rise Time | t_r | | - | 3 | - | nS |
| Turn-Off Delay Time | $t_{\text{d(off)}}$ | | - | 15 | - | nS |
| Turn-Off Fall Time | t_f | | - | 2 | - | nS |
| Total Gate Charge | Q_g | $V_{\text{DS}}=20\text{V}, I_{\text{D}}=8\text{A}, V_{\text{GS}}=10\text{V}$ | - | 12 | - | nC |
| Gate-Source Charge | Q_{gs} | | - | 3.2 | - | nC |
| Gate-Drain Charge | Q_{gd} | | - | 3.1 | - | nC |
| Drain-Source Diode Characteristics | | | | | | |
| Diode Forward Voltage ^(Note 3) | V_{SD} | $V_{\text{GS}}=0\text{V}, I_{\text{S}}=8\text{A}$ | - | 0.8 | 1.2 | V |



P-CH Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|--|-----------------------------------|--|------|------|----------|------------------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=-250\mu\text{A}$ | -40 | - | - | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $\text{V}_{\text{DS}}=-40\text{V}, \text{V}_{\text{GS}}=0\text{V}$ | - | - | -1 | μA |
| Gate-Body Leakage Current | I_{GSS} | $\text{V}_{\text{GS}}=\pm20\text{V}, \text{V}_{\text{DS}}=0\text{V}$ | - | - | ±100 | nA |
| On Characteristics ^(Note 3) | | | | | | |
| Gate Threshold Voltage | $\text{V}_{\text{GS}(\text{th})}$ | $\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=-250\mu\text{A}$ | -1.0 | -1.5 | -2.0 | V |
| Drain-Source On-State Resistance | $\text{R}_{\text{DS}(\text{ON})}$ | $\text{V}_{\text{GS}}=-10\text{V}, \text{I}_D=-8\text{A}$ | - | 29 | 35 | $\text{m}\Omega$ |
| | | $\text{V}_{\text{GS}}=-4.5\text{V}, \text{I}_D=-4\text{A}$ | - | 34 | 45 | $\text{m}\Omega$ |
| Forward Transconductance | g_{FS} | $\text{V}_{\text{DS}}=-5\text{V}, \text{I}_D=-8\text{A}$ | 20 | - | - | S |
| Dynamic Characteristics ^(Note 4) | | | | | | |
| Input Capacitance | C_{iss} | $\text{V}_{\text{DS}}=-20\text{V}, \text{V}_{\text{GS}}=0\text{V},$ $F=1.0\text{MHz}$ | - | 520 | - | PF |
| Output Capacitance | C_{oss} | | - | 100 | - | PF |
| Reverse Transfer Capacitance | C_{rss} | | - | 65 | - | PF |
| Switching Characteristics ^(Note 4) | | | | | | |
| Turn-on Delay Time | $t_{\text{d}(\text{on})}$ | $\text{V}_{\text{DD}}=-20\text{V}, \text{R}_{\text{L}}=2.3\Omega$ $\text{V}_{\text{GS}}=-10\text{V}, \text{R}_{\text{GEN}}=6\Omega$ | - | 7.5 | - | nS |
| Turn-on Rise Time | t_r | | - | 5.5 | - | nS |
| Turn-Off Delay Time | $t_{\text{d}(\text{off})}$ | | - | 19 | - | nS |
| Turn-Off Fall Time | t_f | | - | 7 | - | nS |
| Total Gate Charge | Q_g | $\text{V}_{\text{DS}}=-20\text{V}, \text{I}_D=-8\text{A}$ $\text{V}_{\text{GS}}=-10\text{V}$ | - | 13 | - | nC |
| Gate-Source Charge | Q_{gs} | | - | 3.8 | - | nC |
| Gate-Drain Charge | Q_{gd} | | - | 3.1 | - | nC |
| Drain-Source Diode Characteristics | | | | | | |
| Diode Forward Voltage ^(Note 3) | V_{SD} | $\text{V}_{\text{GS}}=0\text{V}, \text{I}_s=-10\text{A}$ | - | - | -1.2 | V |

N- Channel Typical Electrical and Thermal Characteristics (Curves)

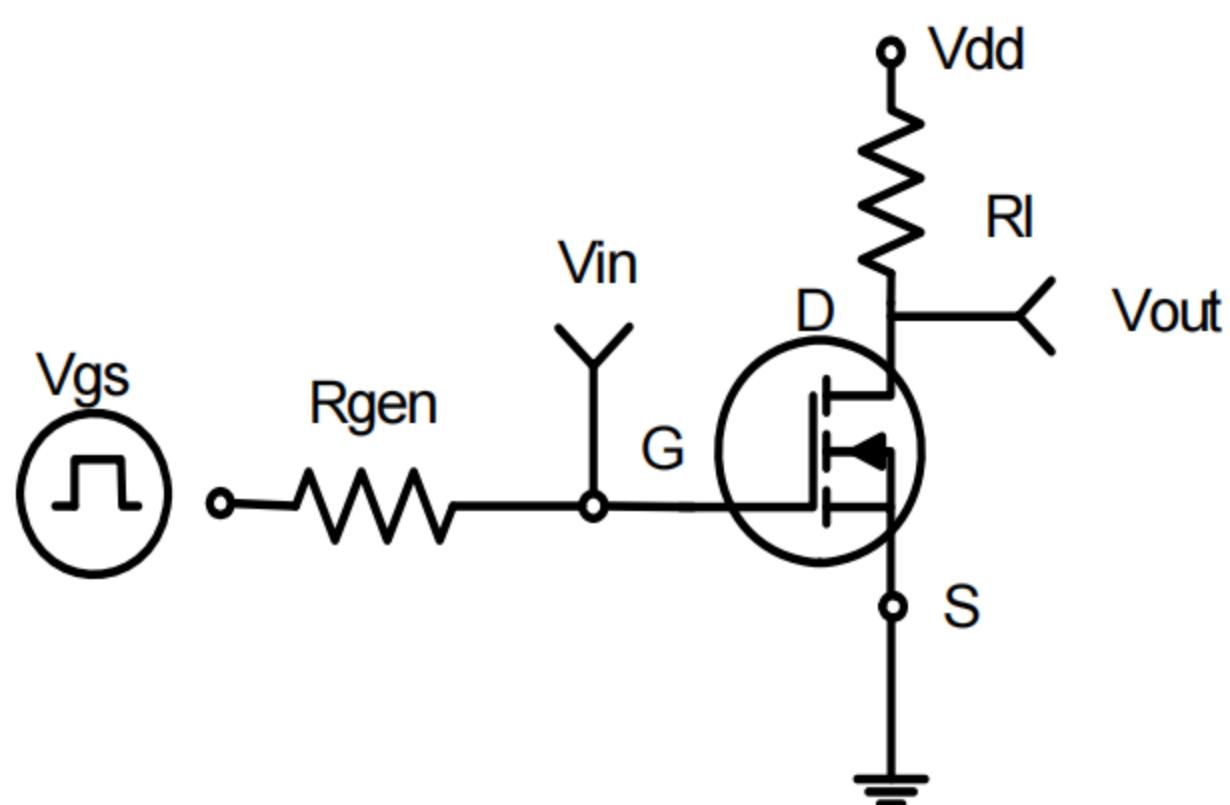


Figure 1:Switching Test Circuit

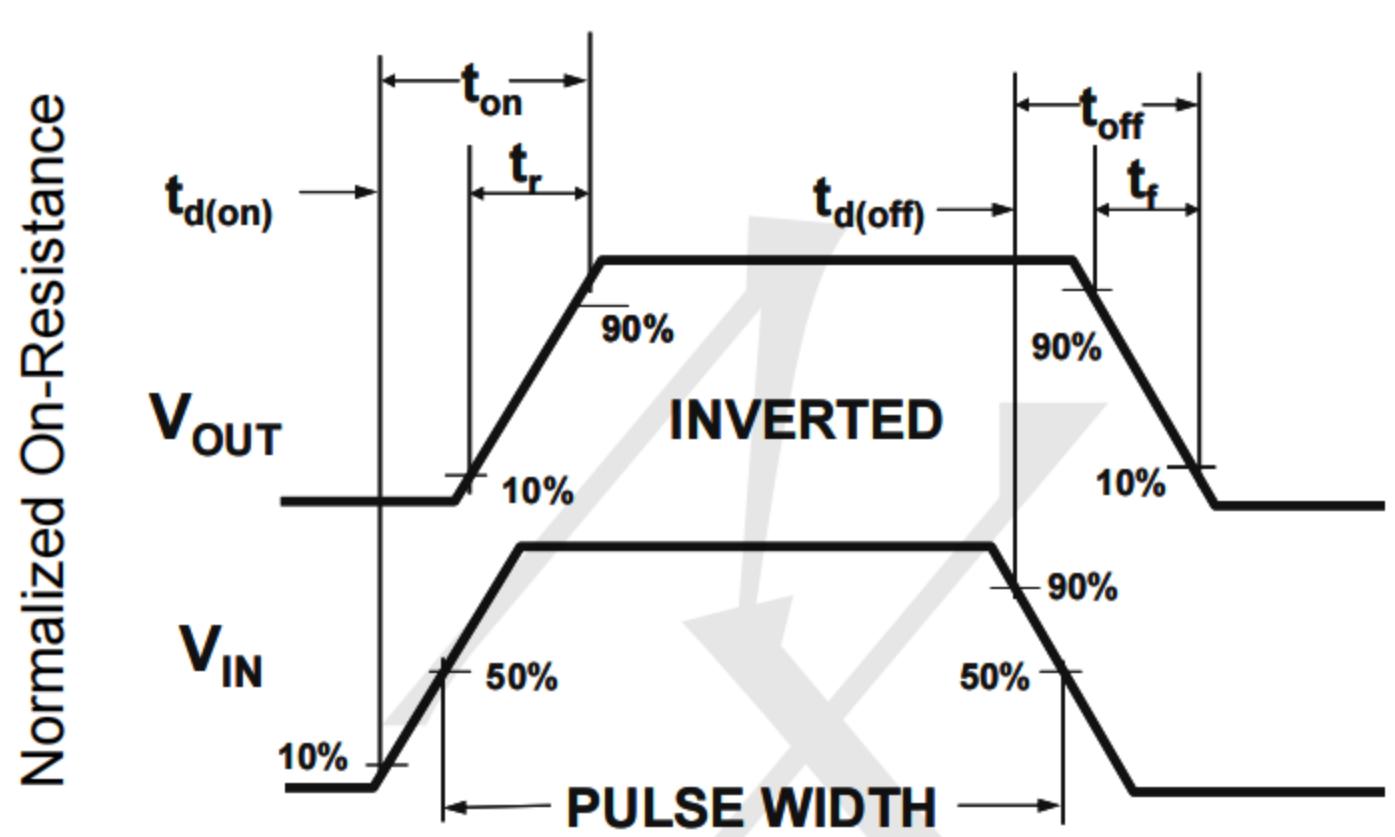


Figure 2:Switching Waveforms

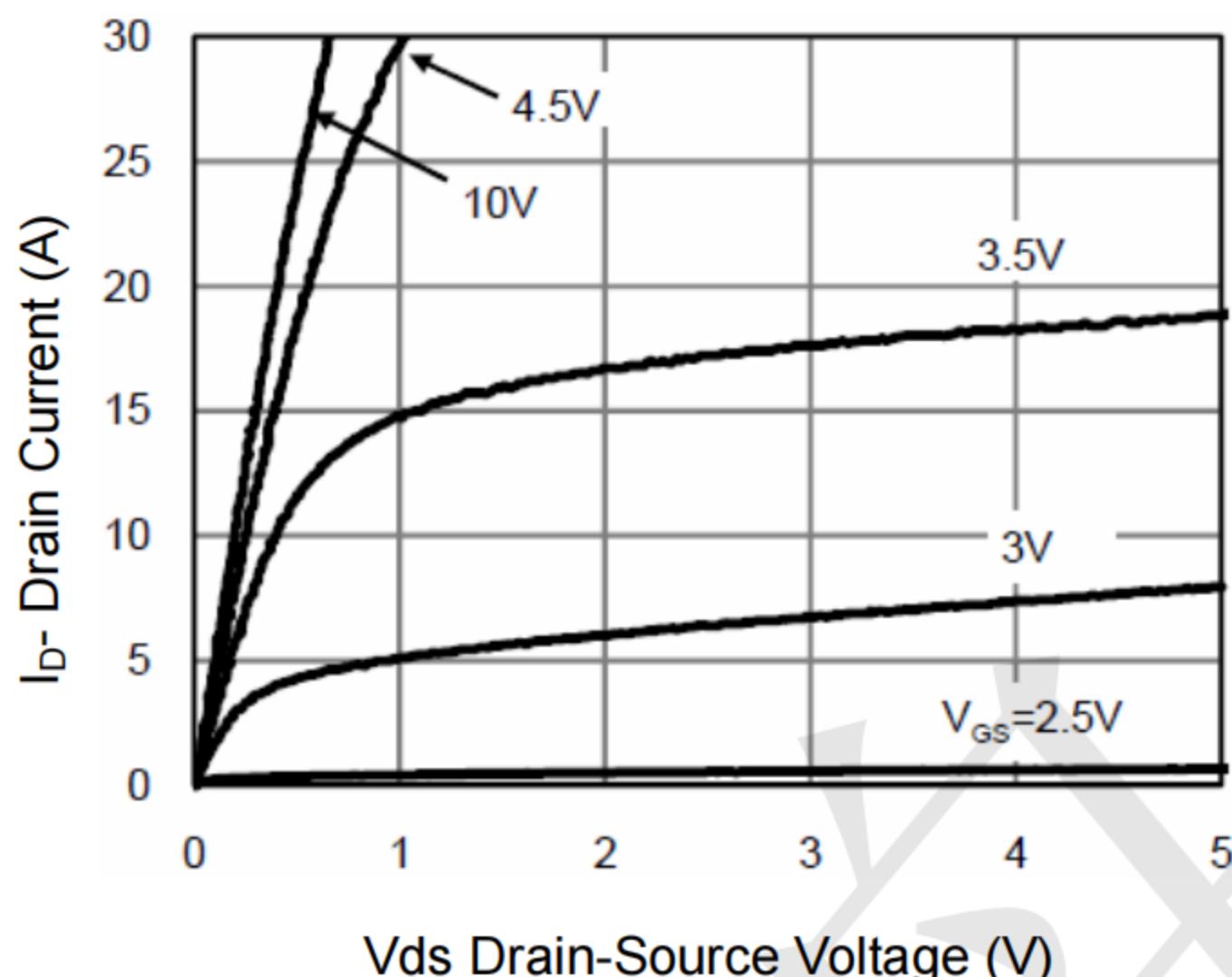


Figure 3 Output Characteristics

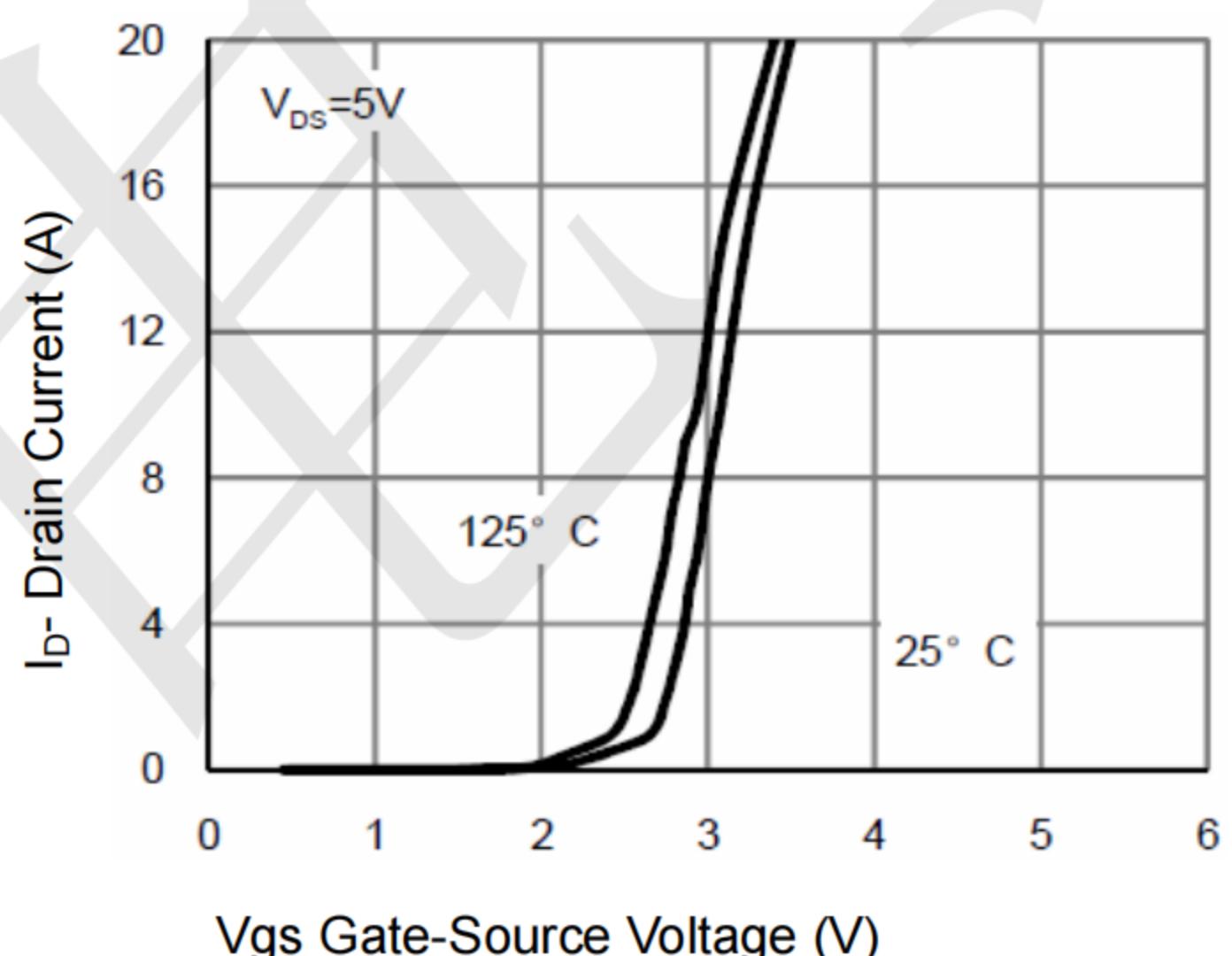


Figure 4 Transfer Characteristics

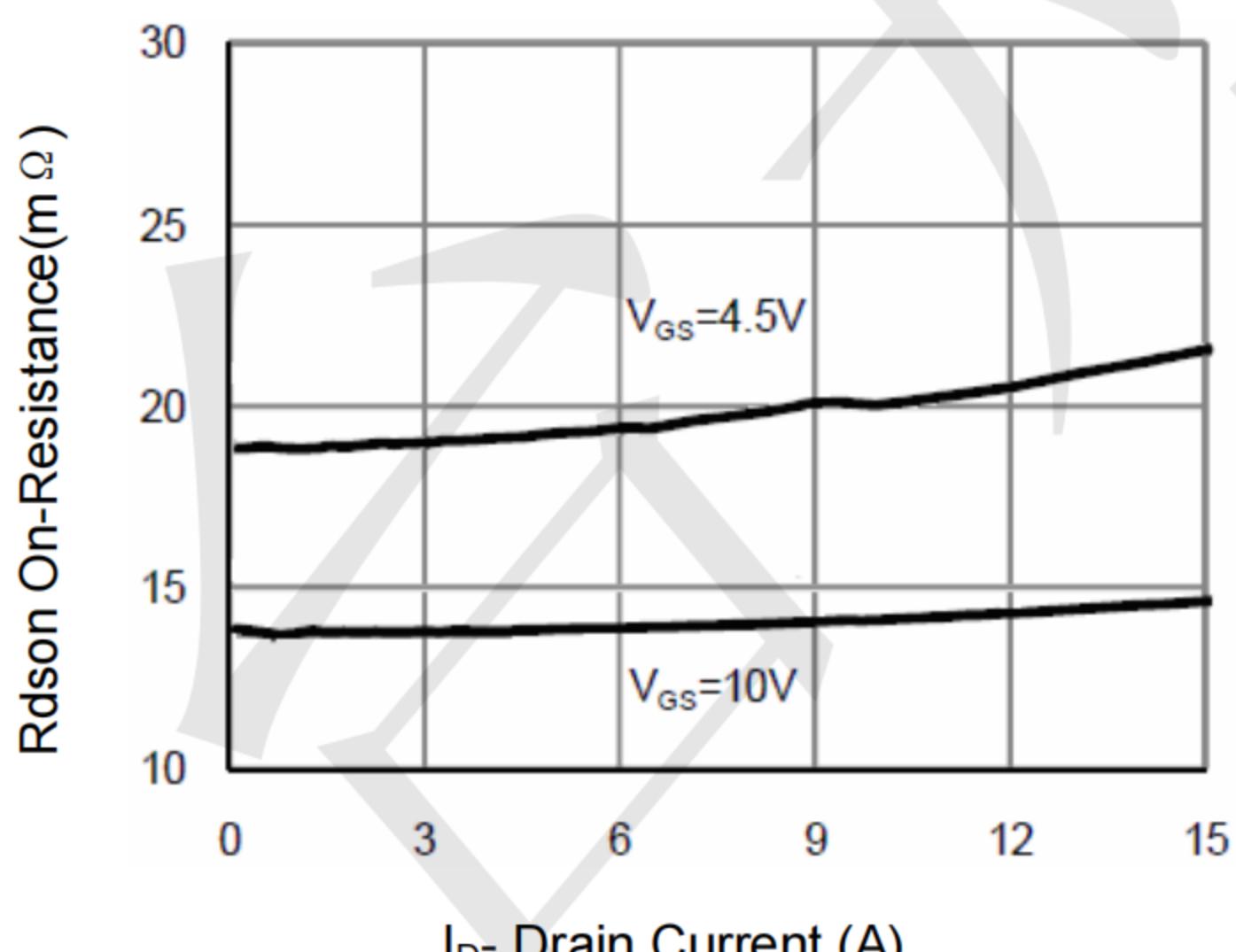


Figure 5 Drain-Source On-Resistance

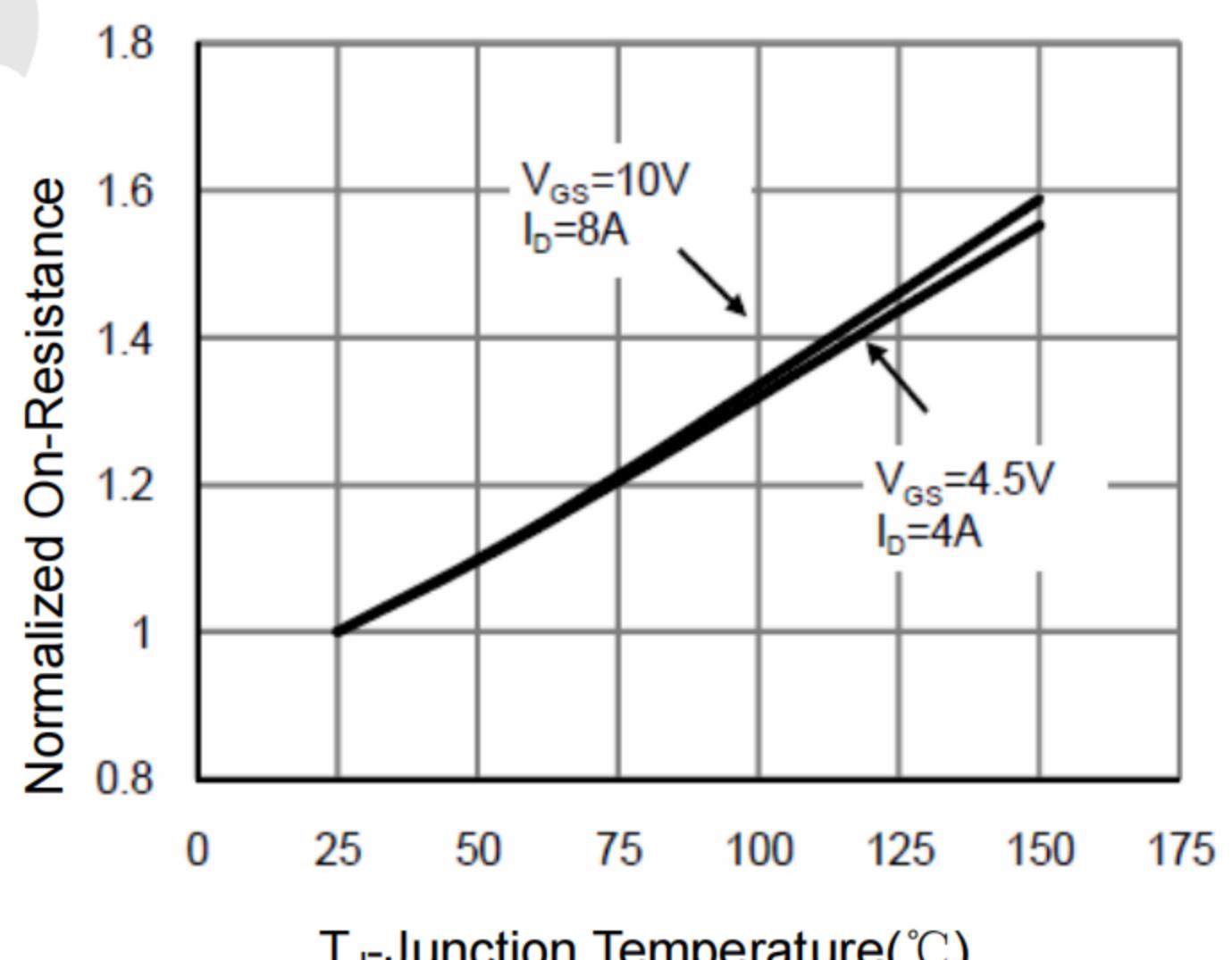
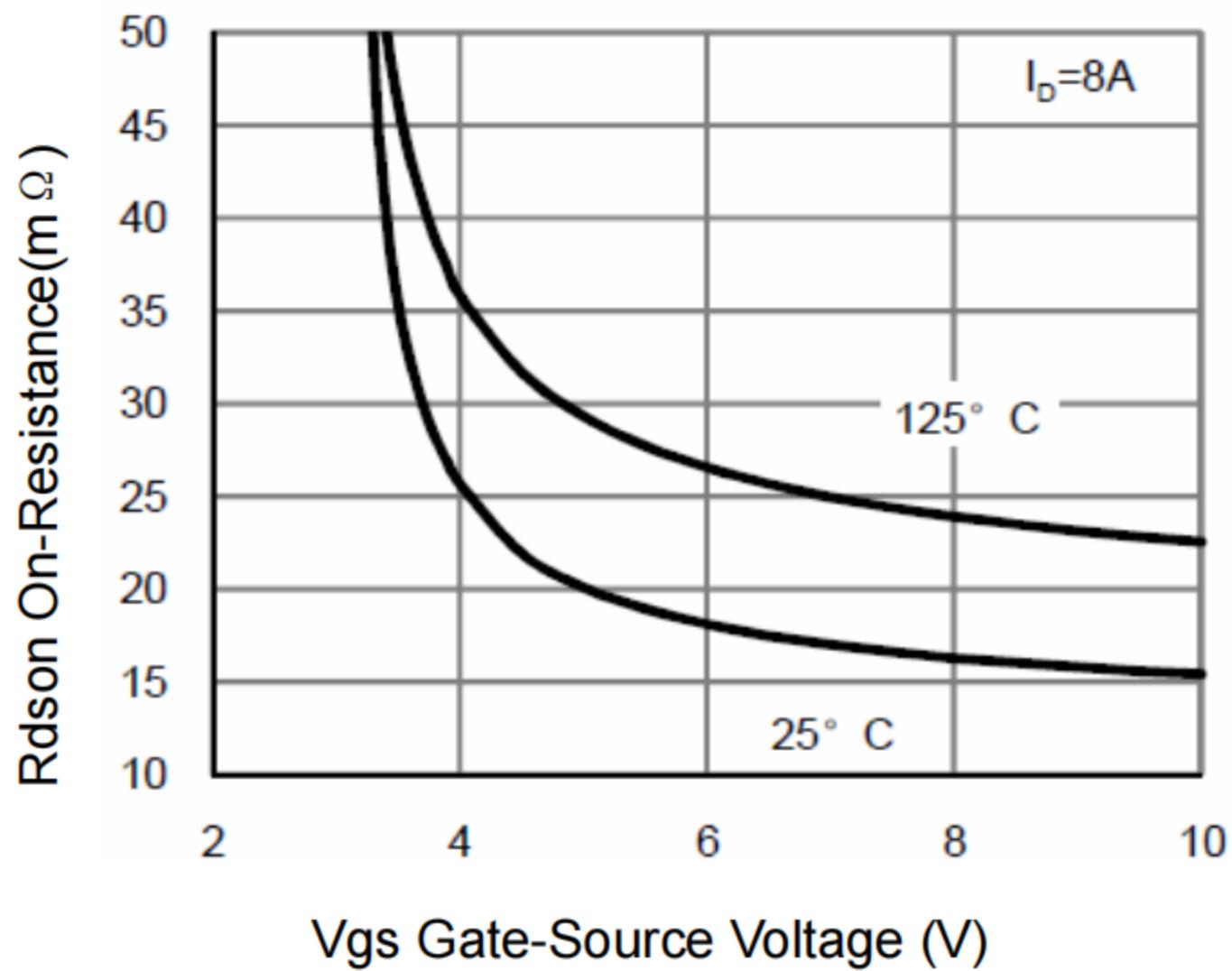
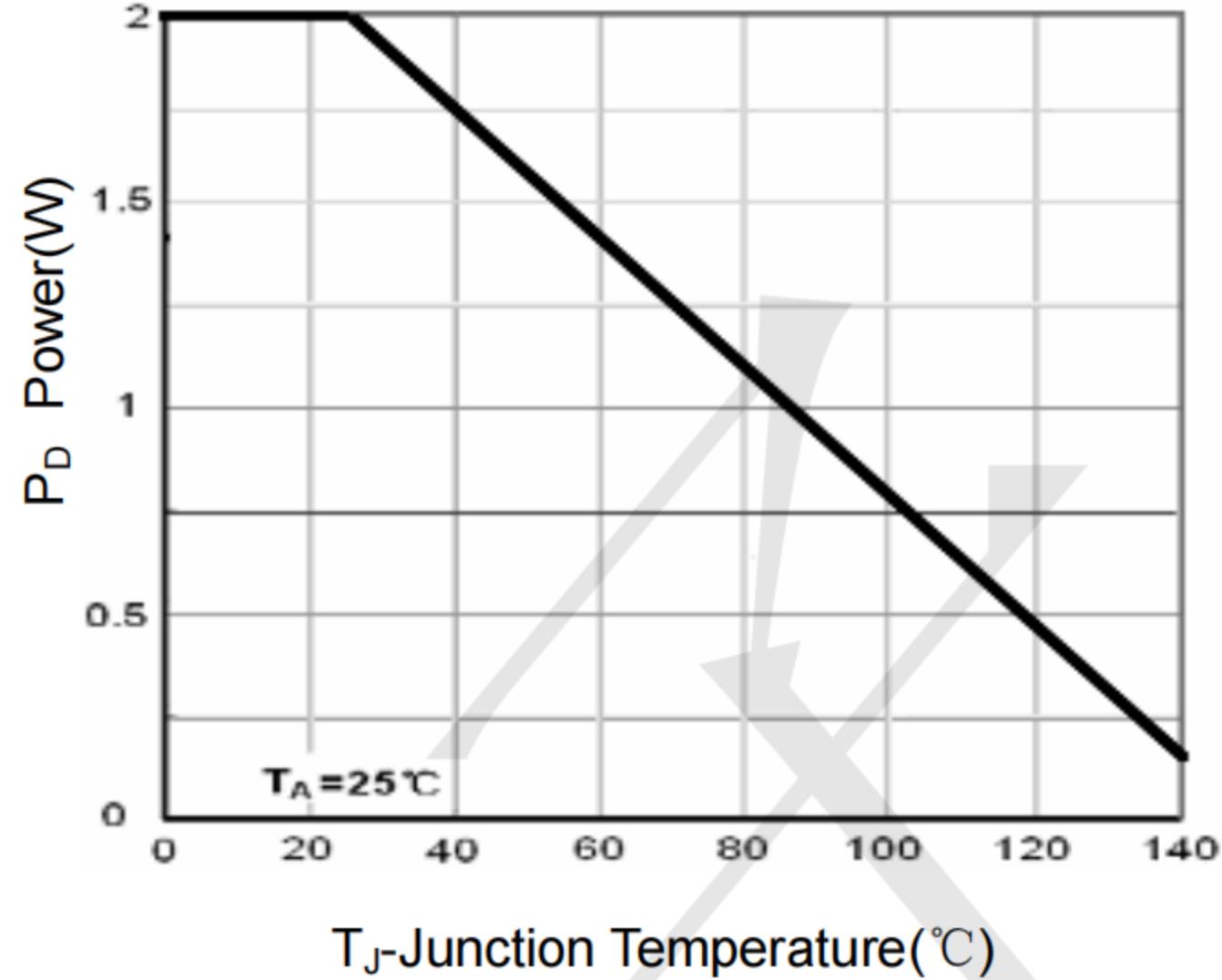
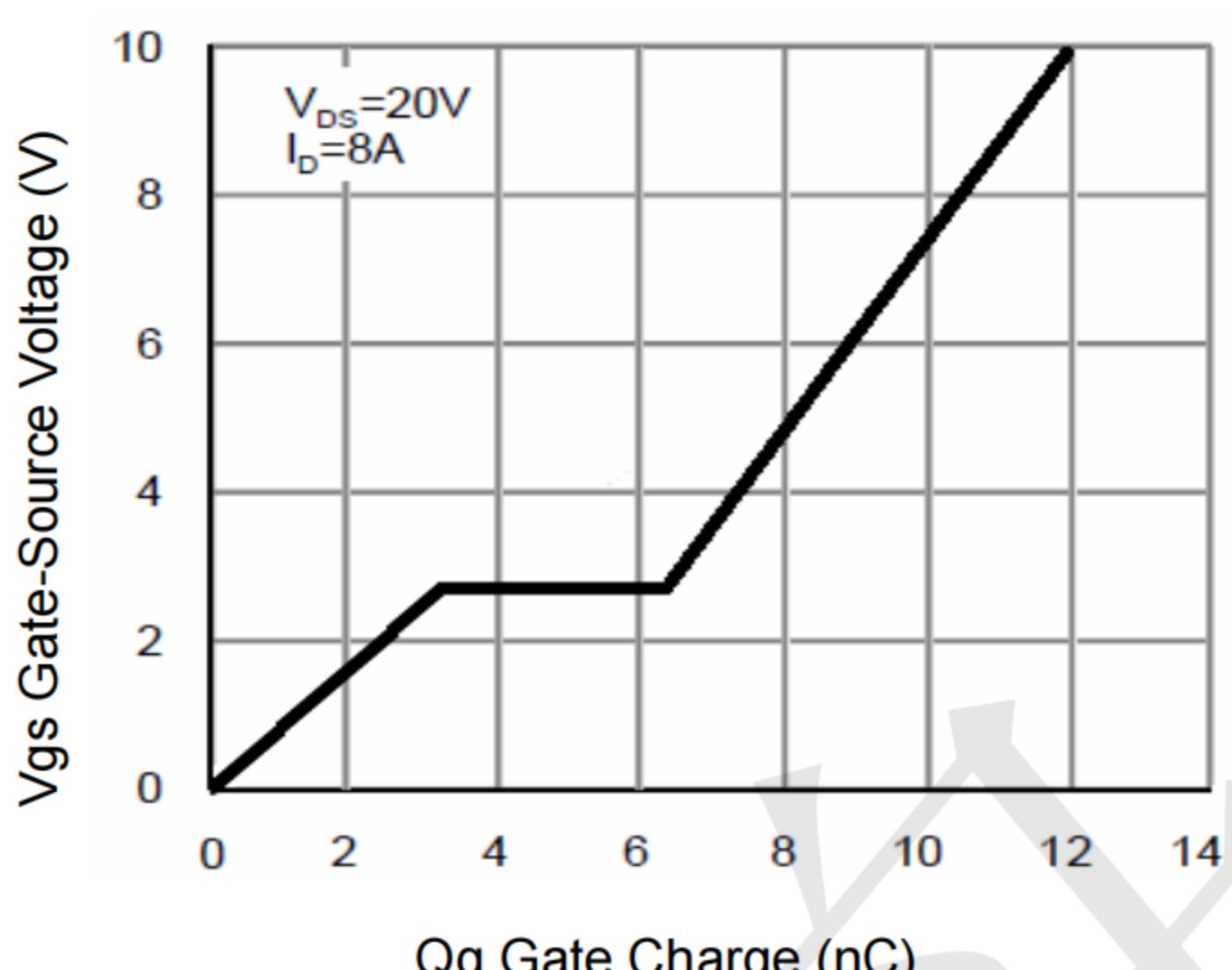
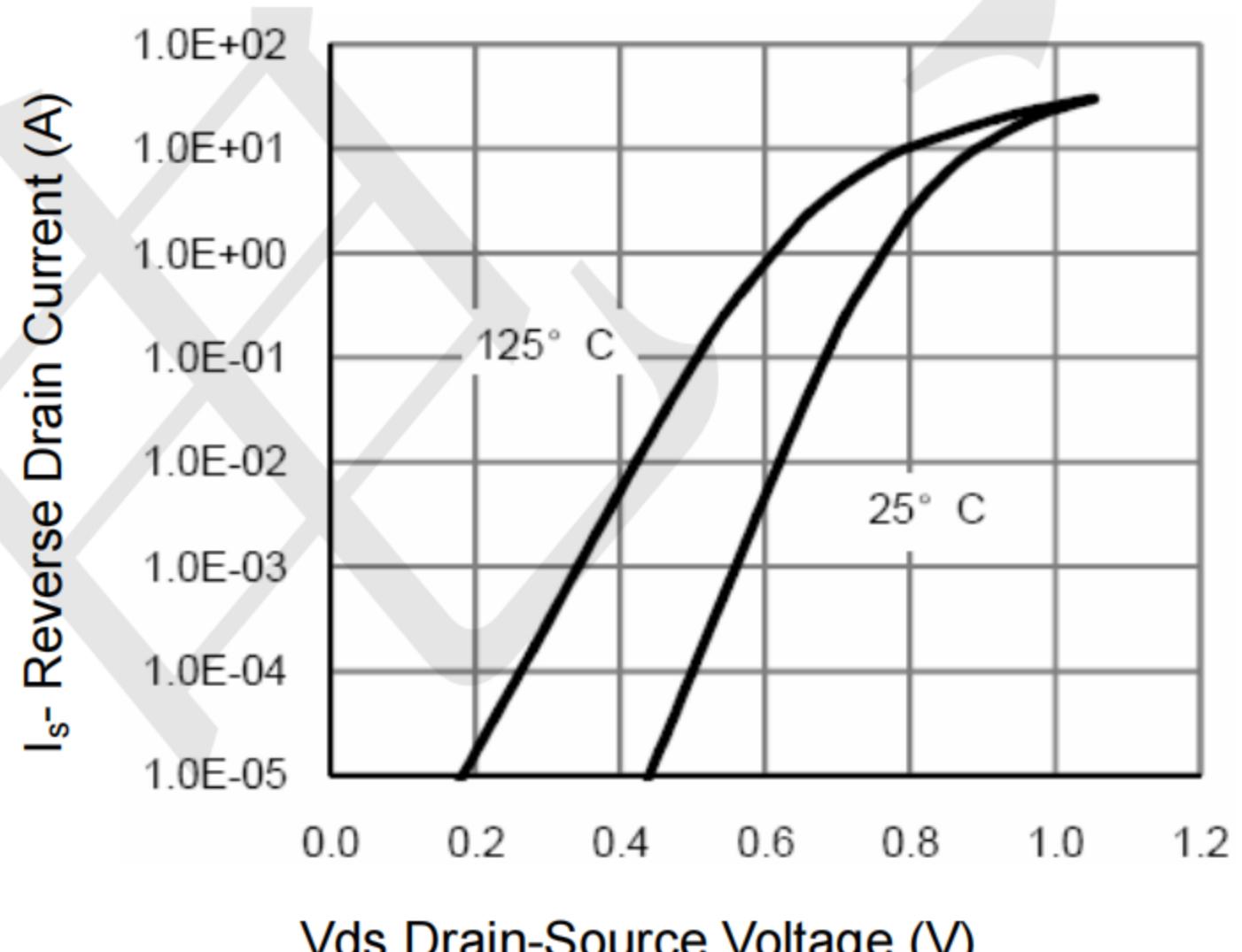
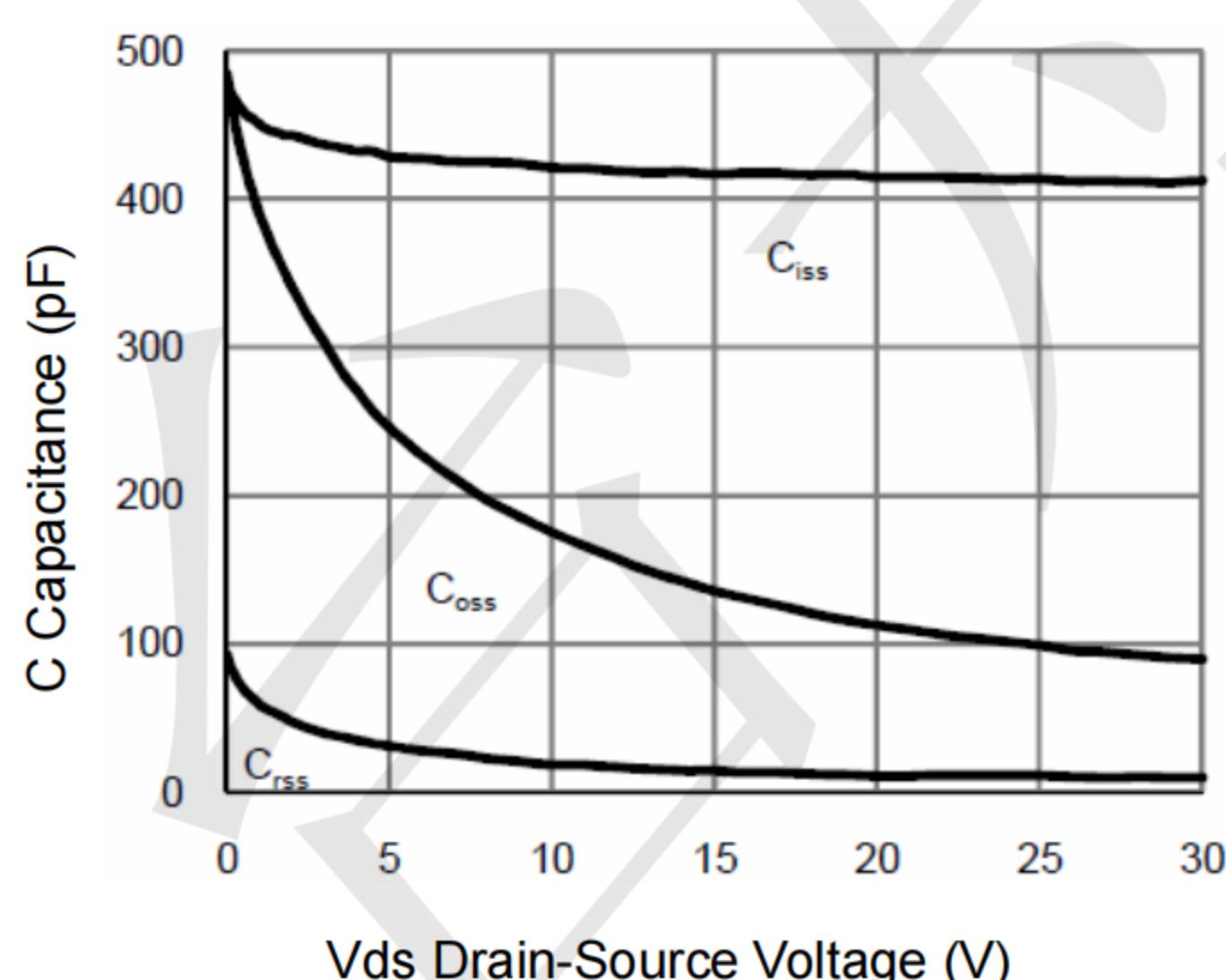
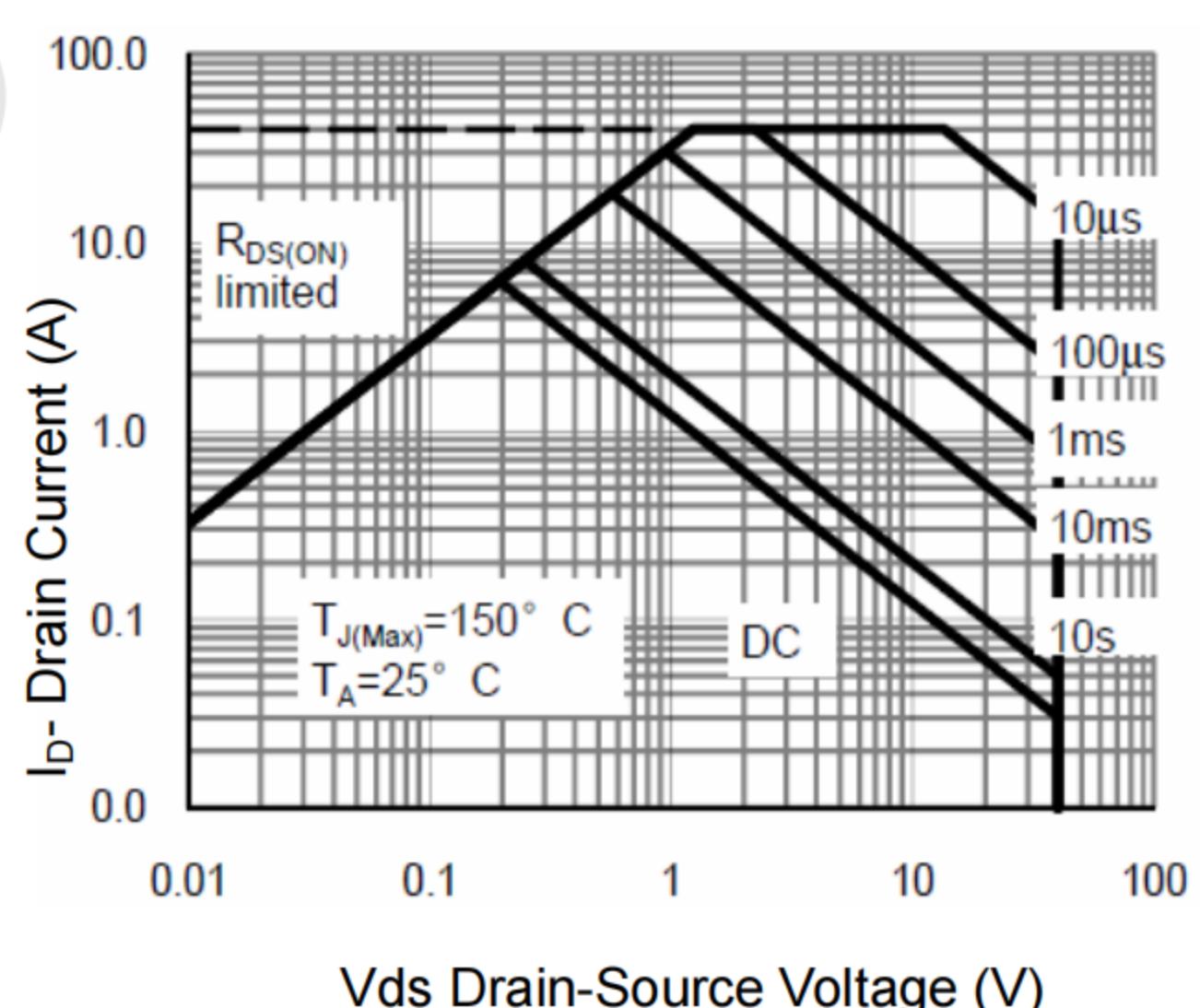


Figure 6 Drain-Source On-Resistance


Figure 7 Rdson vs Vgs

Figure 8 Power Dissipation

Figure 9 Gate Charge

Figure 10 Source- Drain Diode Forward

Figure 11 Capacitance vs Vds

Figure 12 Safe Operation Area

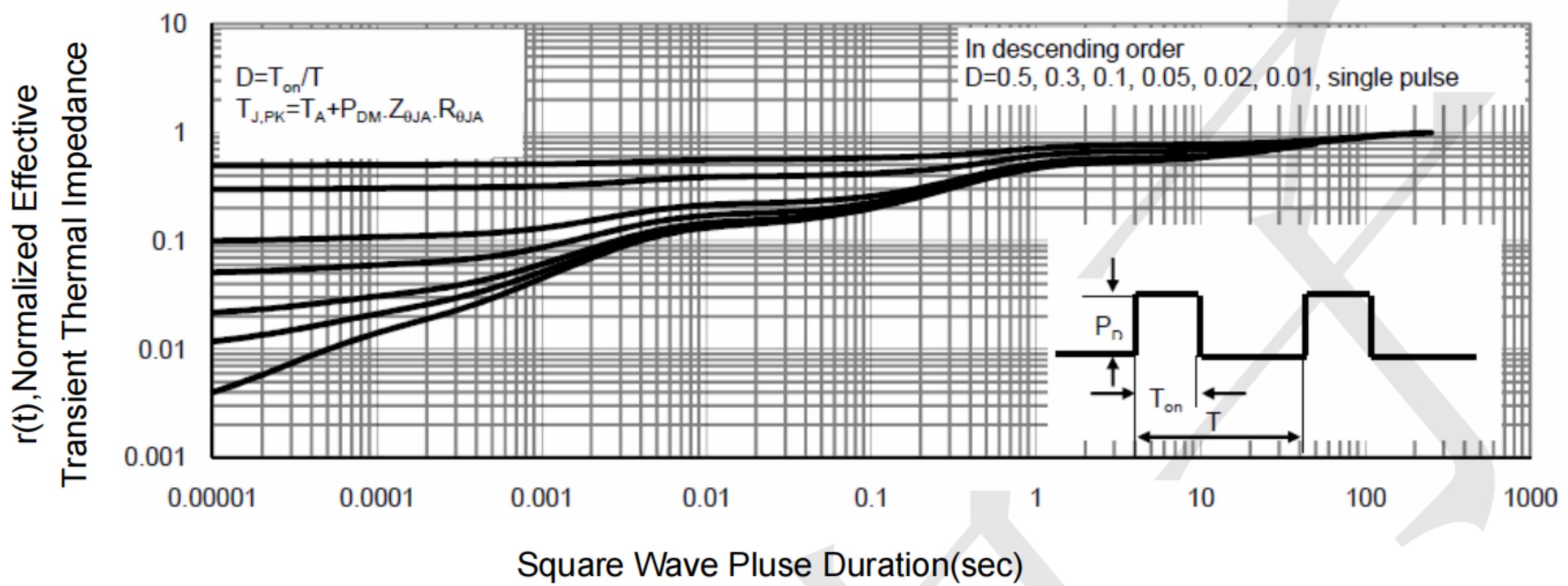


Figure 13 Normalized Maximum Transient Thermal Impedance

P- Channel Typical Electrical and Thermal Characteristics (Curves)

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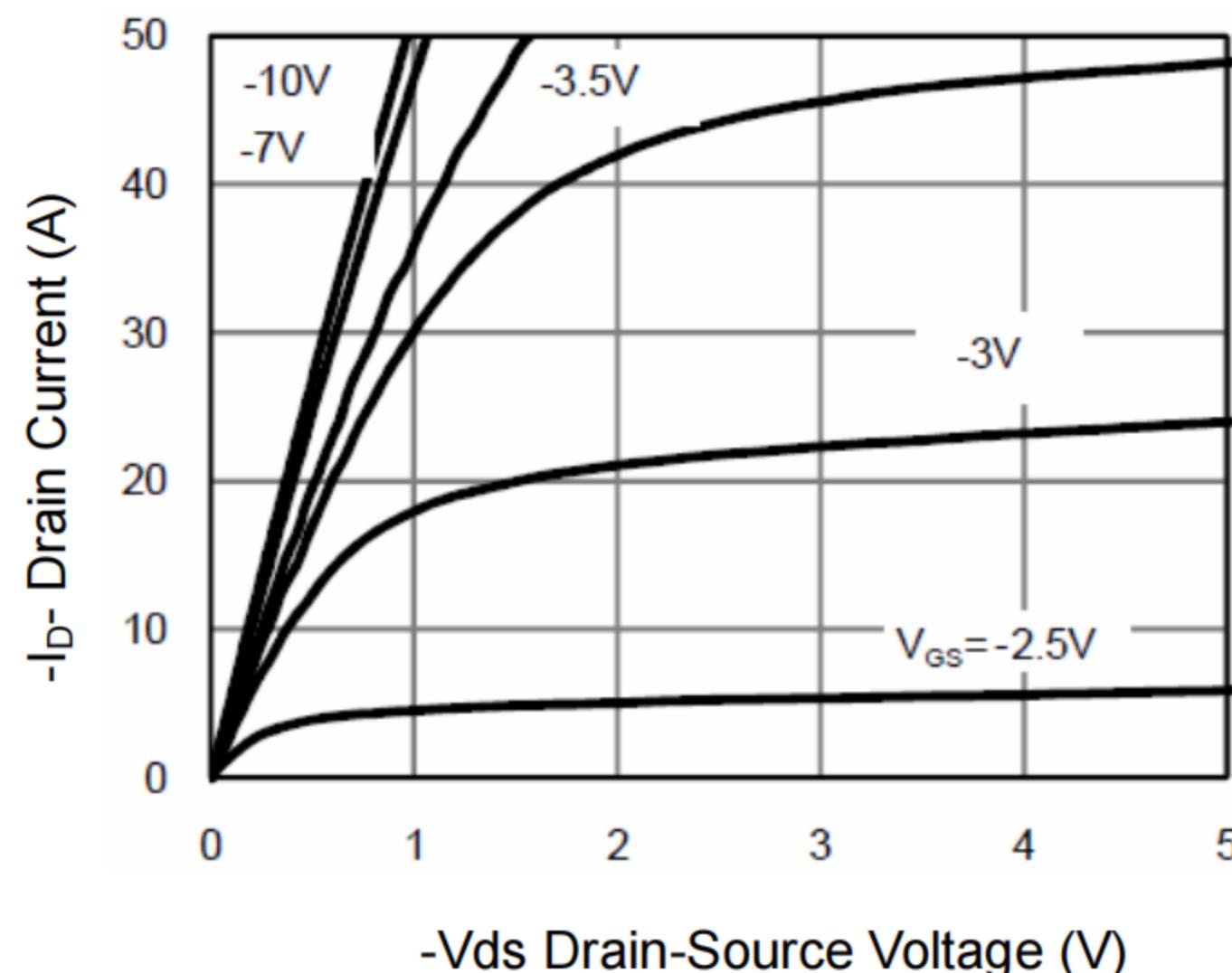


Figure 1 Output Characteristics

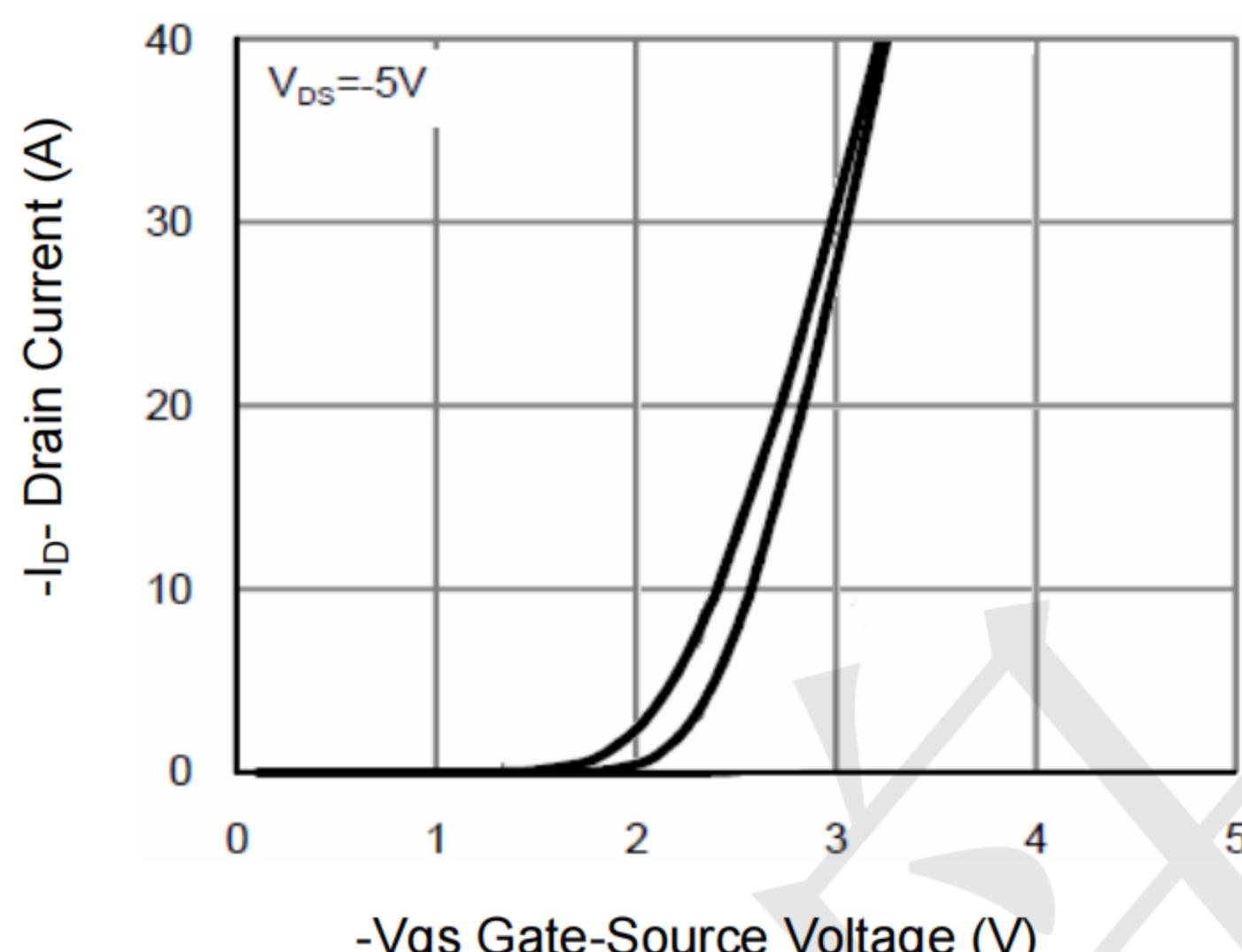


Figure 2 Transfer Characteristics

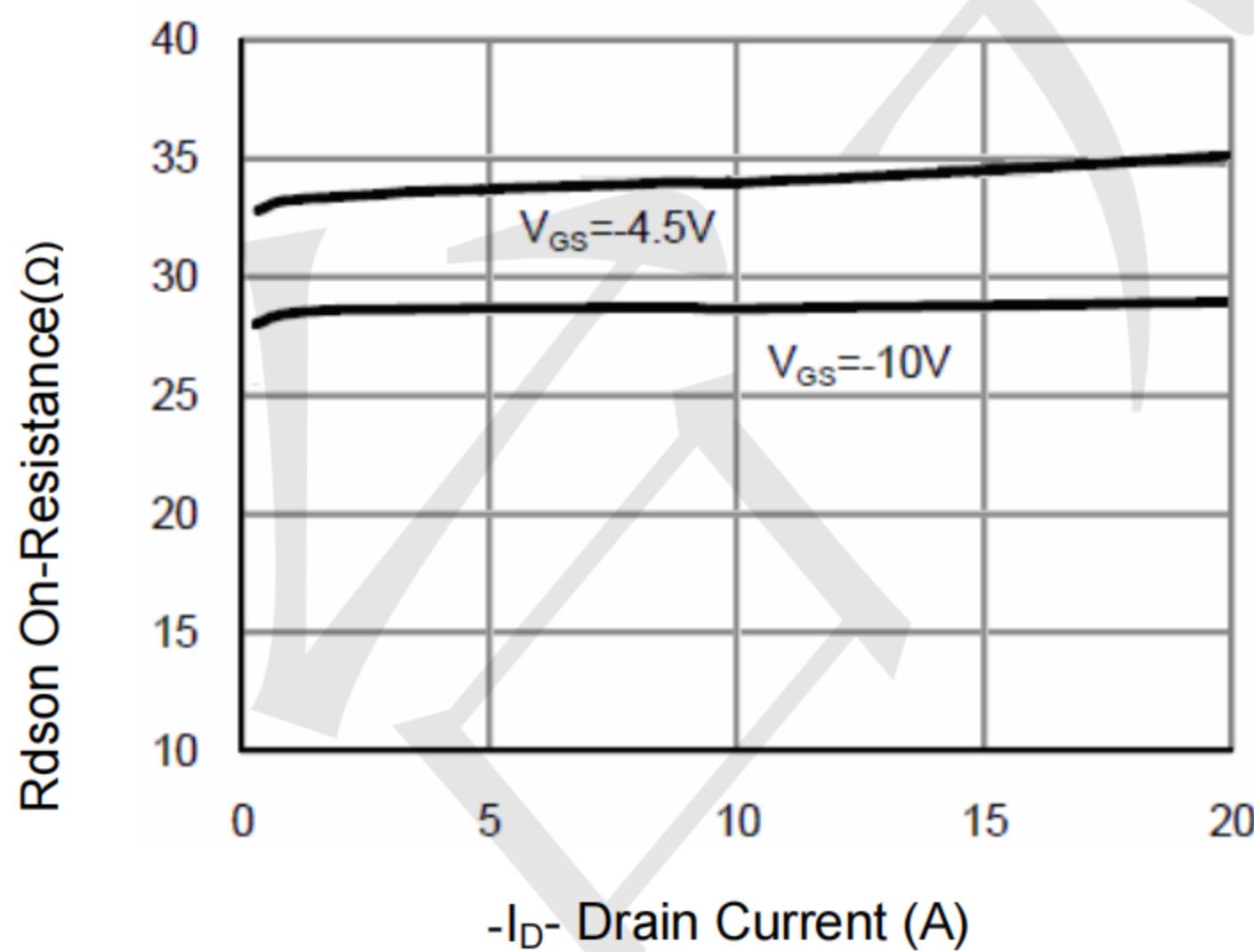


Figure 3 Rdson- Drain Current

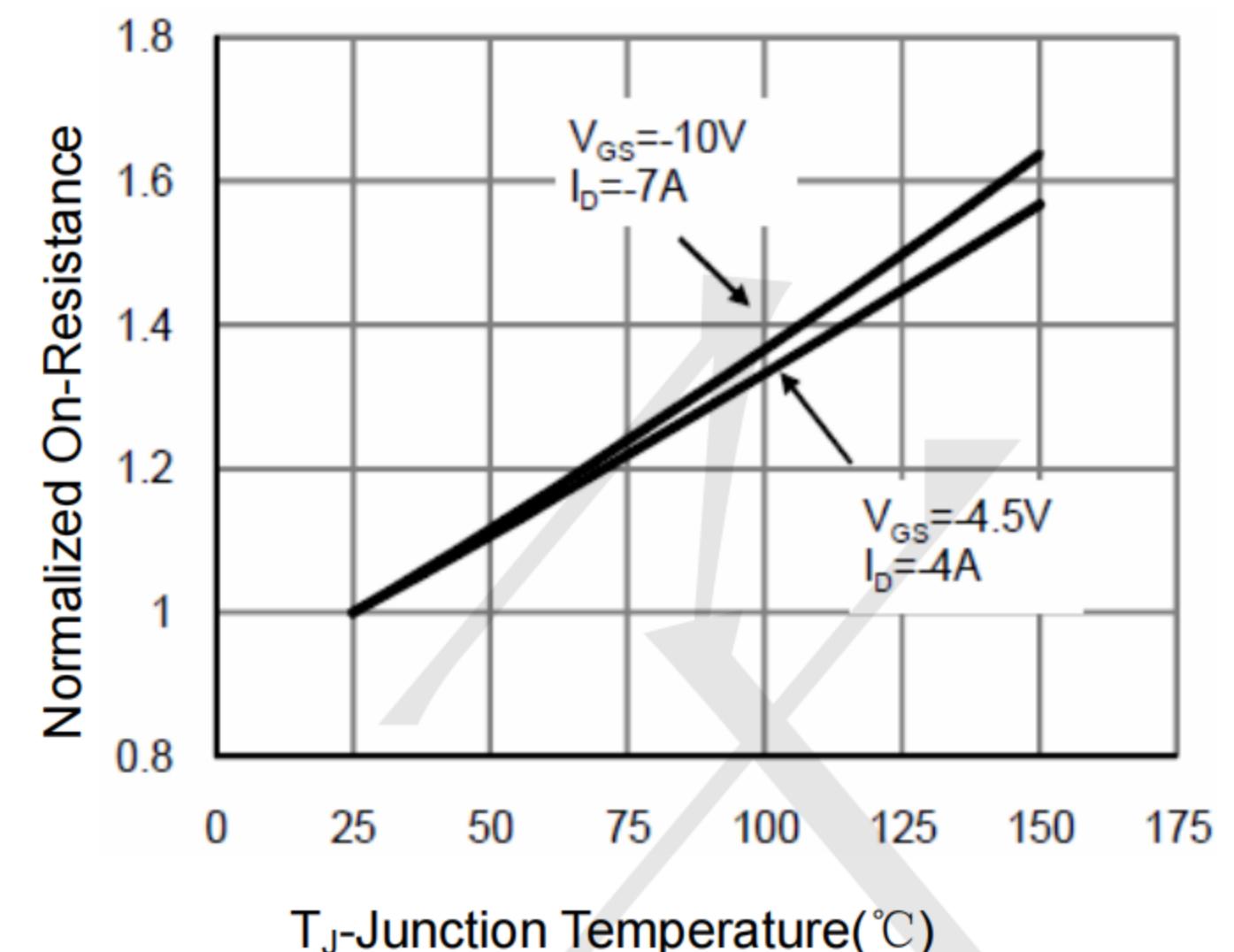


Figure 4 Rdson-Junction Temperature

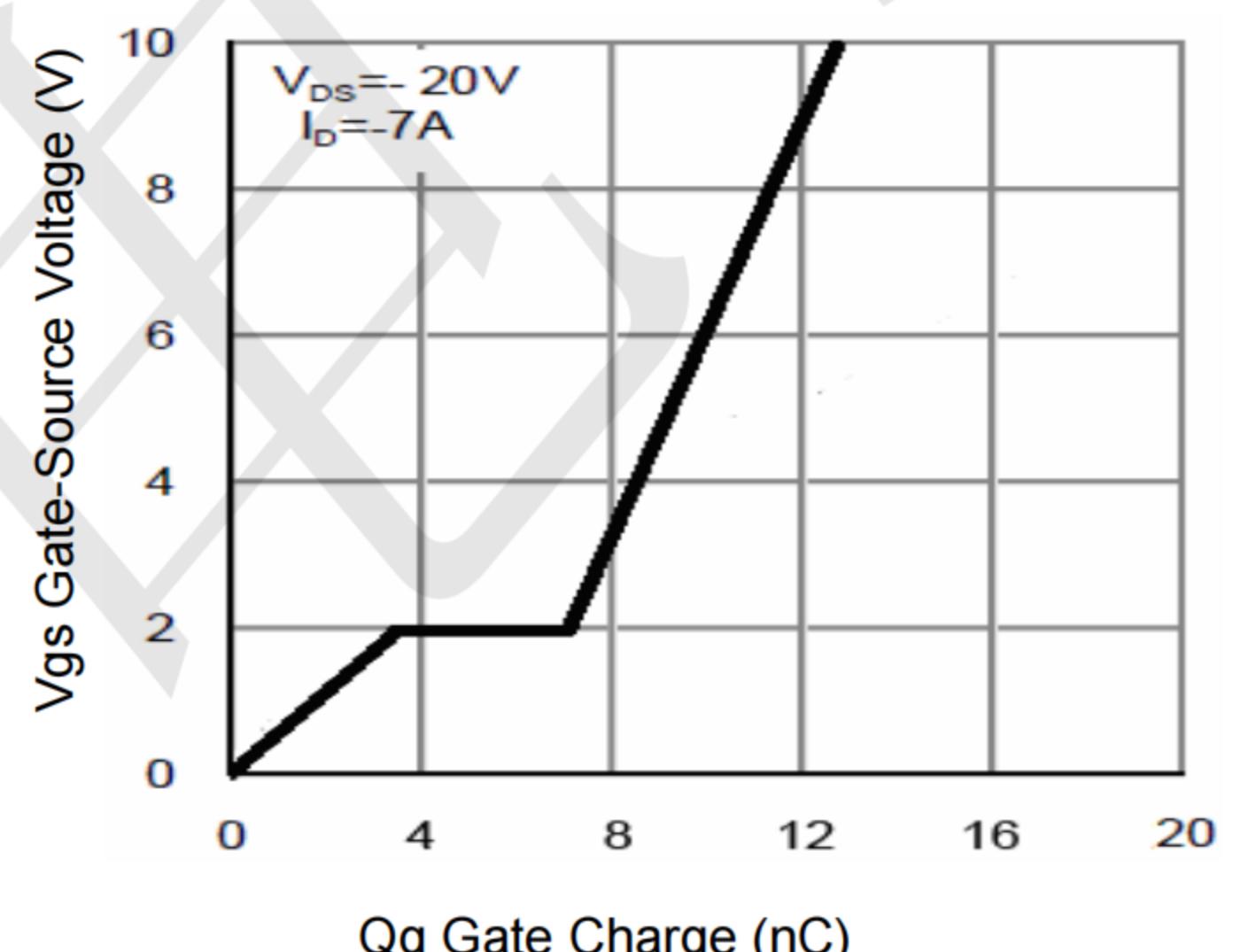


Figure 5 Gate Charge

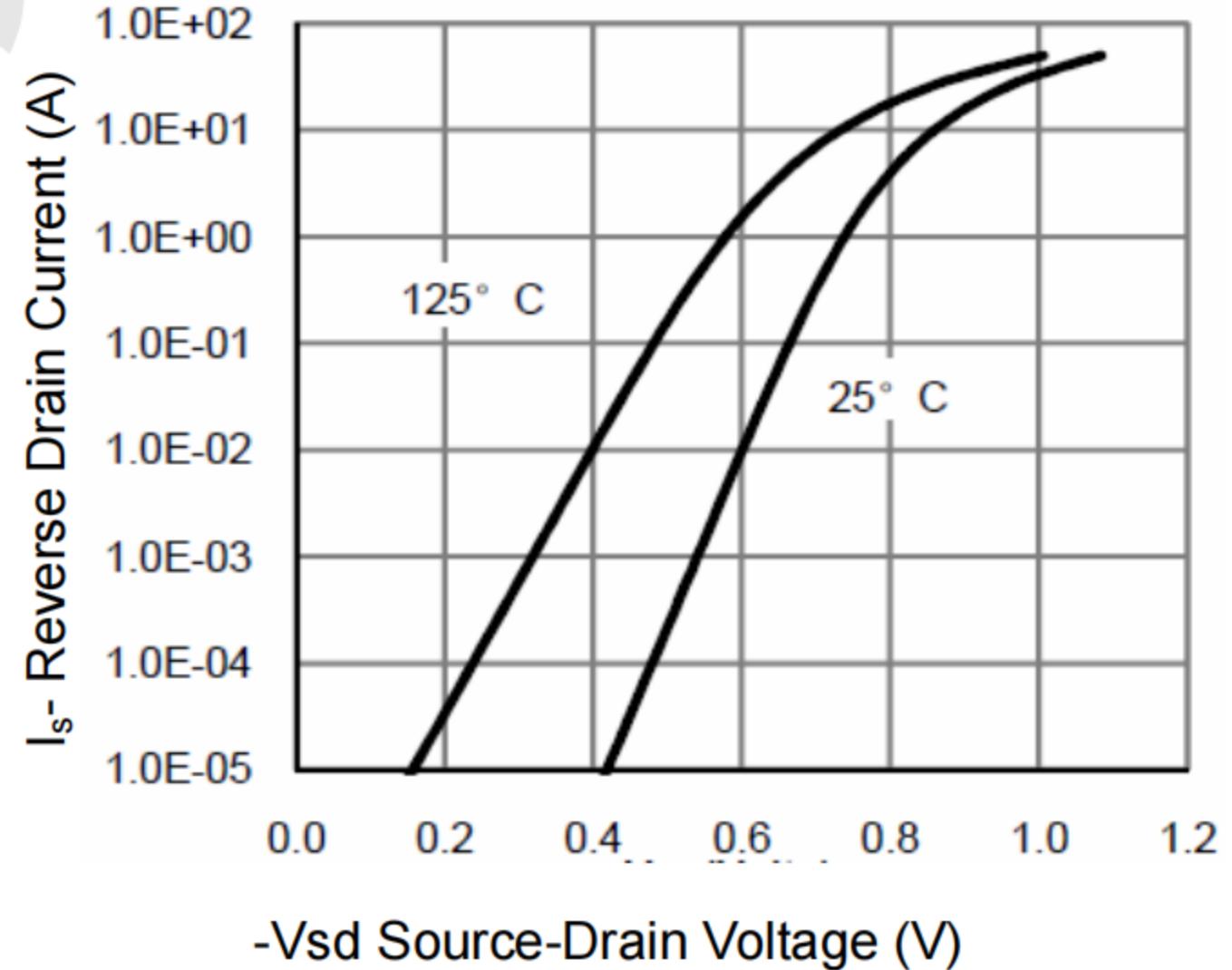


Figure 6 Source- Drain Diode Forward

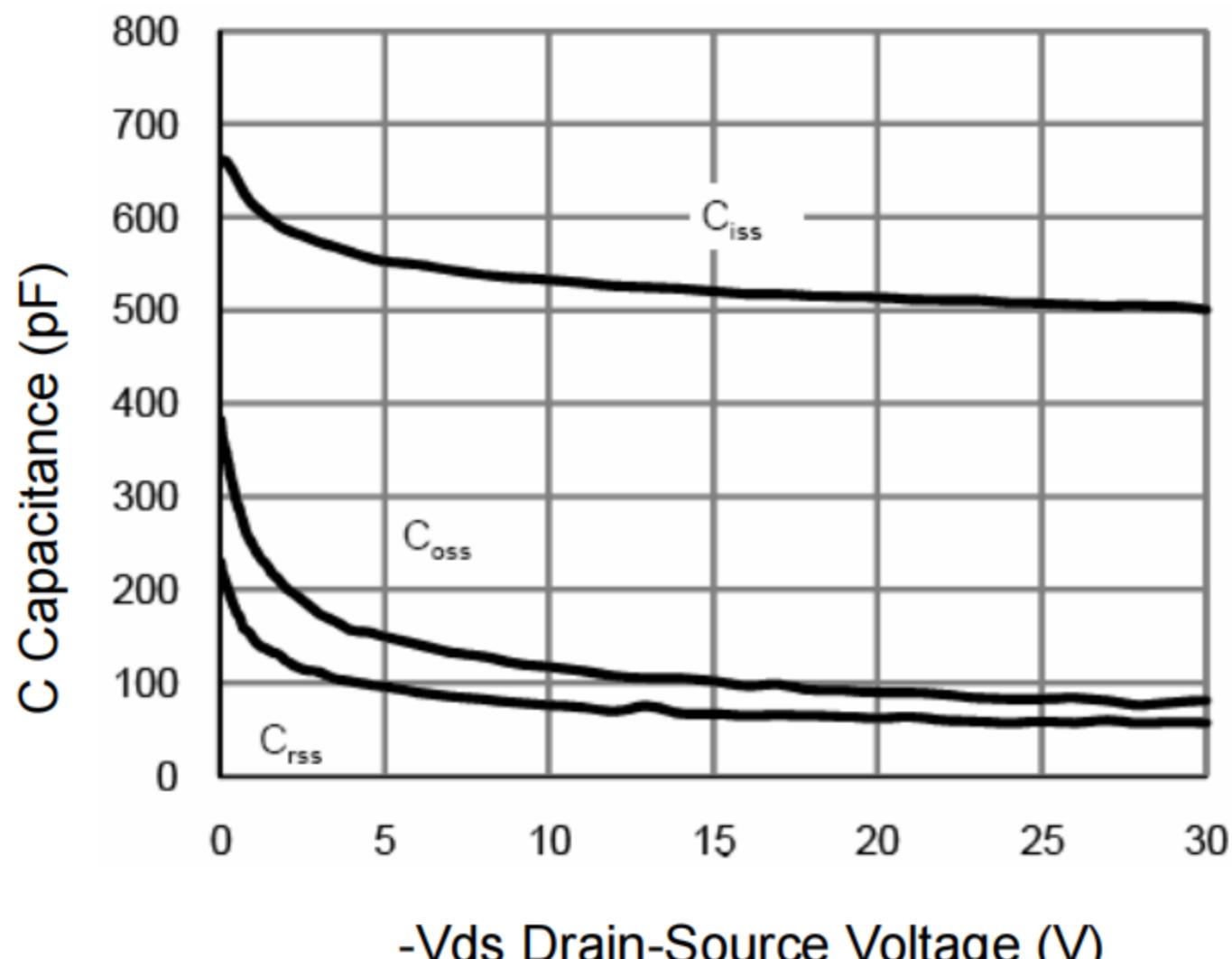


Figure 7 Capacitance vs Vds

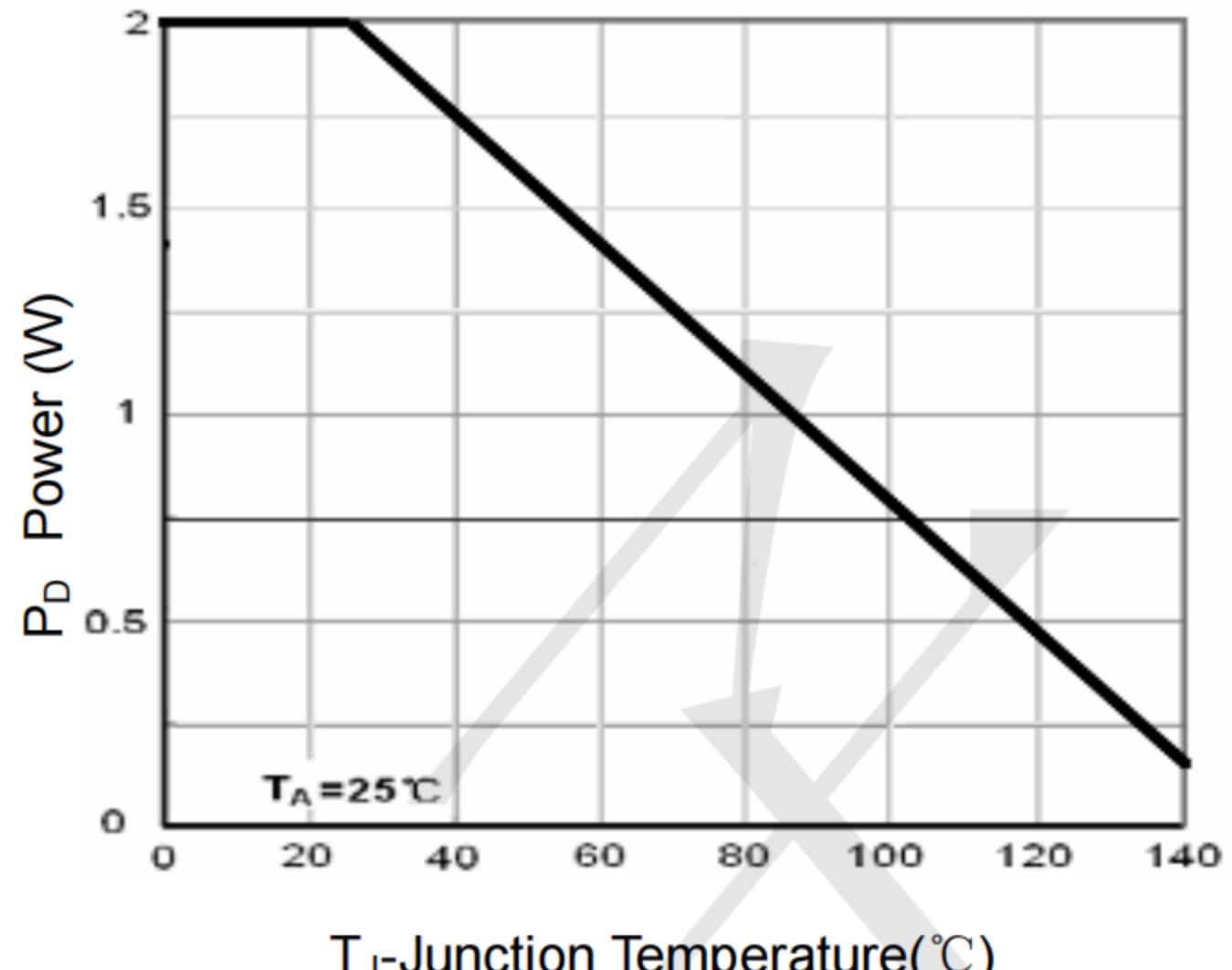


Figure 9 Power Dissipation

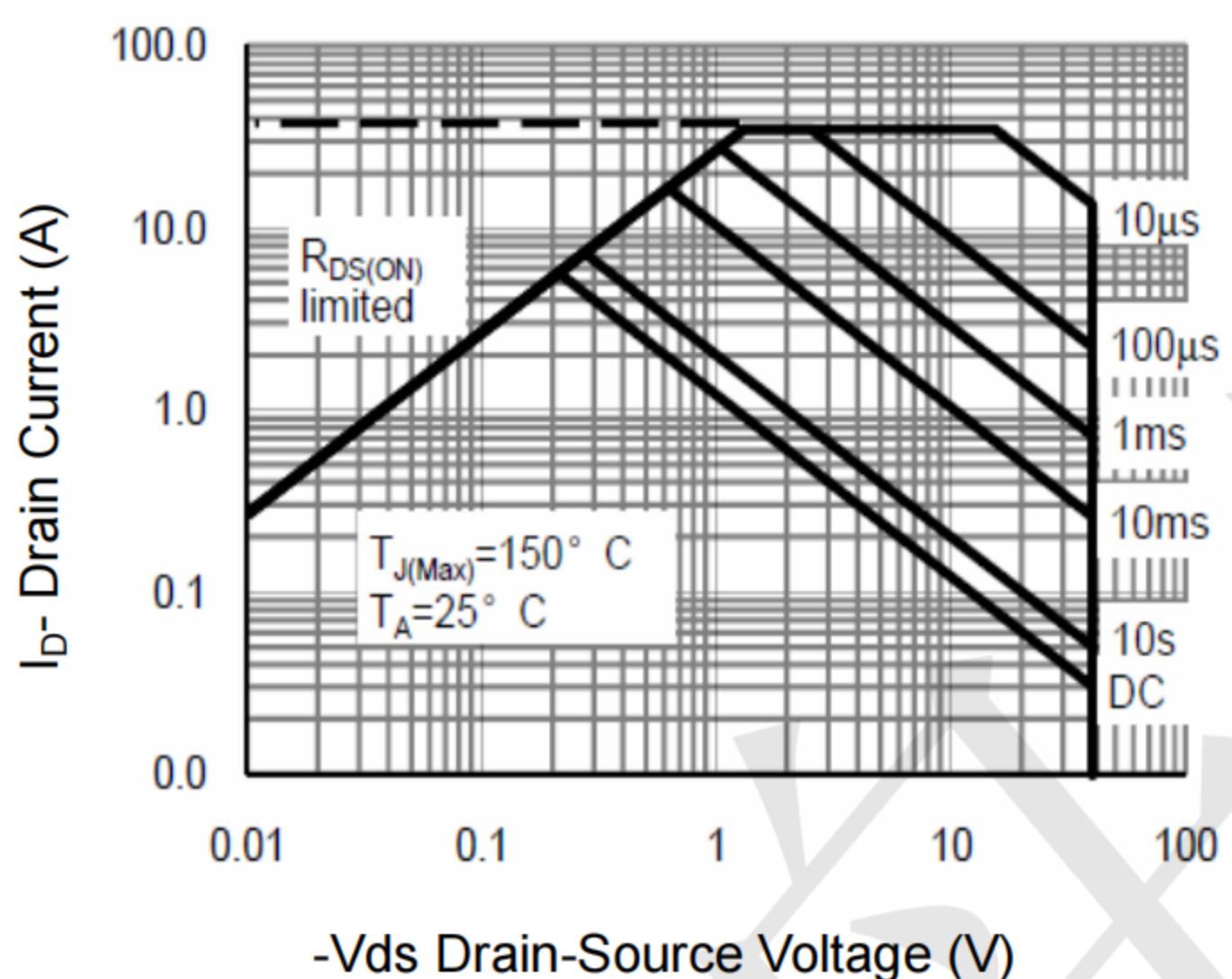


Figure 8 Safe Operation Area

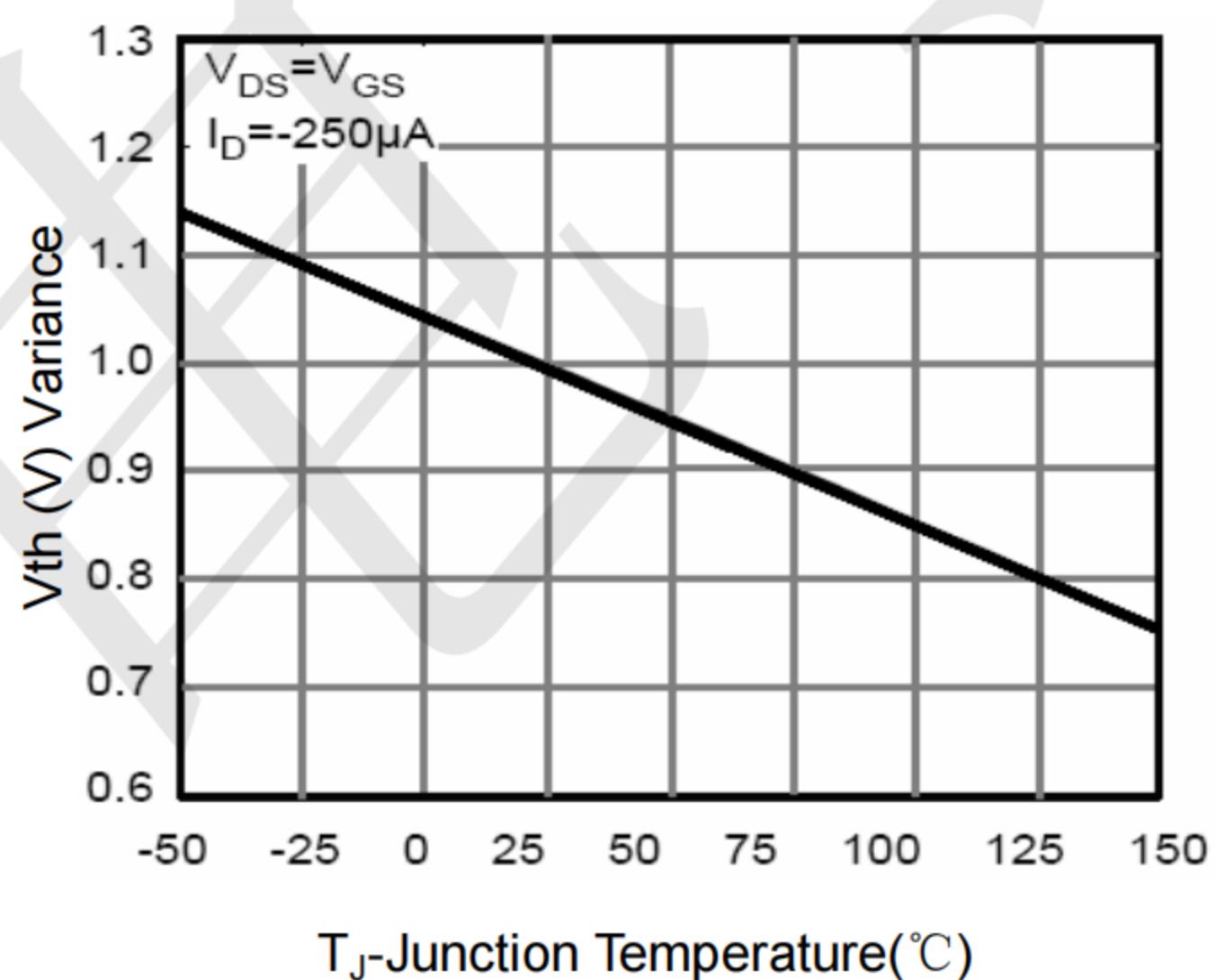


Figure 10 $V_{GS(th)}$ vs Junction Temperature

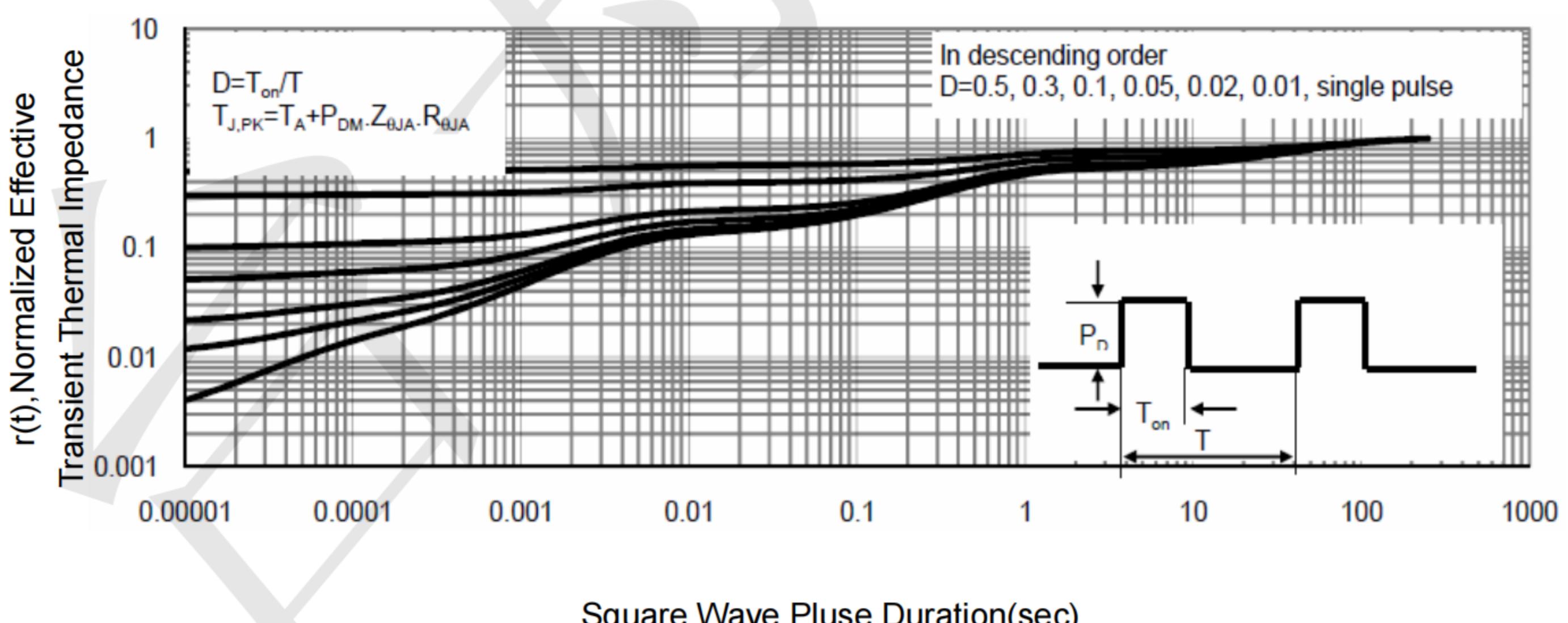
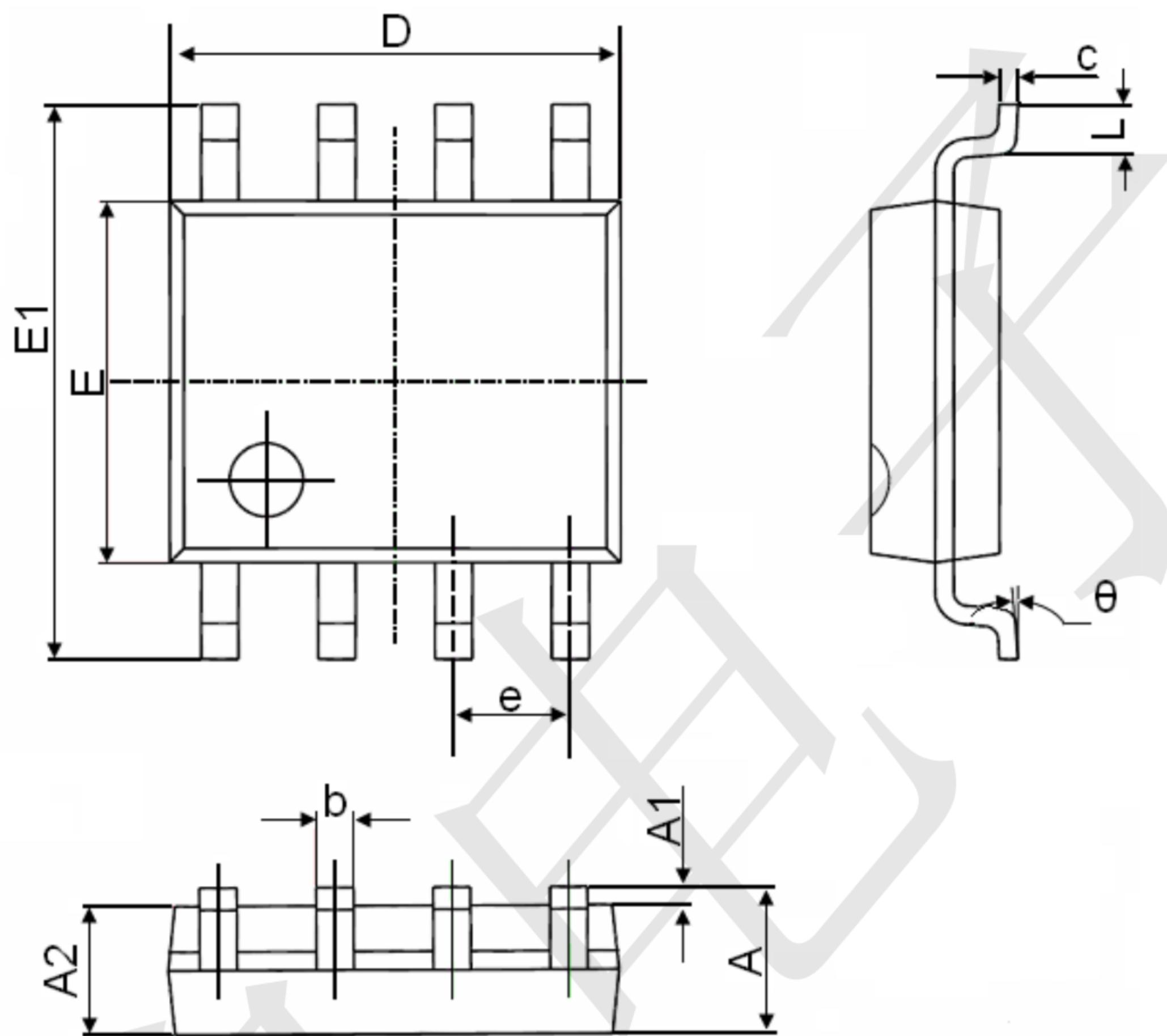


Figure 11 Normalized Maximum Transient Thermal Impedance

SOP-8 Package Information



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 1.350 | 1.750 | 0.053 | 0.069 |
| A1 | 0.100 | 0.250 | 0.004 | 0.010 |
| A2 | 1.350 | 1.550 | 0.053 | 0.061 |
| b | 0.330 | 0.510 | 0.013 | 0.020 |
| c | 0.170 | 0.250 | 0.006 | 0.010 |
| D | 4.700 | 5.100 | 0.185 | 0.200 |
| E | 3.800 | 4.000 | 0.150 | 0.157 |
| E1 | 5.800 | 6.200 | 0.228 | 0.244 |
| e | 1.270(BSC) | | 0.050(BSC) | |
| L | 0.400 | 1.270 | 0.016 | 0.050 |
| θ | 0° | 8° | 0° | 8° |